



Trusted Foundry Program

As of 27 September 2019

Accredited Suppliers

Important: Many of the following suppliers have a standard commercial (untrusted) product flow in addition to a trusted product flow. The "Trusted Product Flow" must be explicitly requested from the points of contact below to ensure the resulting product and/or service is trusted. A trusted supply chain begins with trusted design and continues with trusted mask, foundry, packaging/assembly, and test services.

Supplier	CAGE Code	Facility Location	Scope of Accreditation	POC	Email Address	Telephone Number
Aeroflex Colorado Springs - Cobham Colorado Spring	65342	Colorado Springs, CO	Broker; Design; Aggregation; Packaging/Assembly; Test	Michael Newman	mike.newman@cobham.com	(719) 594-8007
Aeroflex Plainview, Inc.	88379	Plainview, NY	Packaging/Assembly	Arthur Mahase	Arthur.Mahase@cobham.com	(516) 752-2448
Arkham Technology Ltd.	47RG0	Irvine, CA	Design	Otaway Thomas, CISSP, ISSEP	othomas@arkhamtechnology.com	(949) 585-0404
Atessa, Inc.	66UM6	Pleasanton, CA	Design	Marketing Manager	info@atessainc.com	(925) 469-0063
BAE Systems Electronic Systems	1RU44	Manassas, VA	Broker; Design; Aggregation; Packaging/Assembly; Test	Stewart Ocheltree	TrustedMicro.vams@baesystems.com	(571) 364-7624
BAE Systems Microelectronics Center Nashua	94117	Nashua, NH	Foundry Services	John Woodhouse	john.woodhouse4@baesystems.com	(603) 885-9570
Boeing Company, The	81205	Seattle, WA	Design	Business Development Manager	Michael.w.carson@boeing.com	(253) 657-8056
Boeing Network and Space Systems (N&SS)	9E831	El Segundo, CA	Design; Test	Eric Miller	Eric.J.Miller@boeing.com	(310) 416-5314
CREE, Inc.	0C9J8	Durham, NC	Design; Foundry Services; Test	Jeff Barner	jeff_barner@cree.com	(919) 287-7515
Criteria Labs, Inc.	1NQ10	Austin, TX	Broker; Packaging/Assembly; Test	Doug Myron	dmyron@criterialabs.com	(512) 637-4549
Defense Microelectronics Activity	088N9	McClellan, CA	Broker; Design; Foundry Services; Packaging/Assembly; Test	Jerry Tucker	tucker@dmea.osd.mil	(916) 231-1593
DPA Components International	6S055	Simi Valley, CA	Packaging/Assembly; Test	Doug Schweitzer	dougs@dpaci.com	(805) 581-9200
Draper	51993	Cambridge, MA	Design; Post Processing; Packaging/Assembly; Test	Rebecca Connell	r.connell@draper.com	p: 617-258-1314 c: 617-599-9927
General Dynamics Mission Systems	3CYA2	Bloomington, MN	Broker; Design	Ray Keele	Ray.keele@gd-ms.com	(916) 246-5492
General Dynamics Mission Systems, Scottsdale	1VPW8	Scottsdale, AZ	Broker; Design	Jim Garvey, Manager ASIC Design Center	James.Garvey@gd-ms.com	(480) 586-3355
GLOBALFOUNDRIES U.S. 2 LLC BTV	7DR37	Essex Junction, VT	Broker; Design; Aggregation; Mask Data Parsing; Mask Manufacturing; Foundry Services; Post Processing; Test	David Sobczak	david.sobczak@globalfoundries.com	(802) 769-2208
GLOBALFOUNDRIES U.S. 2 LLC EFK	7DR38	Hopewell Junction, NY	Foundry Services; Post Processing	David Sobczak	david.sobczak@globalfoundries.com	(802) 769-2208
Grinding & Dicing Services Inc.	3FEJ2	San Jose, CA	Post Processing; Packaging/Assembly	General Manager	info@wafergrind.com	(408)-961-3720
Honeywell Aerospace Plymouth	34168	Plymouth, MN	Broker; Design; Foundry Services; Packaging/Assembly; Test	Barry Johnson, Western States Manager	Barry.W.Johnson@honeywell.com	(763) 954-2118
HRL Laboratories, LLC.	27457	Malibu, CA	Foundry Services	Kay Son, Ph.D.	kson@hrl.com	(310) 317-5977

i3 Electronics, Inc.	70S94	Binghamton, NY	Packaging/Assembly	Michelle Eldred	Michelle.Eldred@i3electronics.com	(607) 238-7077 ext 318
i3 Microsystems, Inc.	80UM5	St. Petersburg, FL 33716	Post Processing; Packaging/Assembly	Justin Borski	Justin.Borski@i3microsystems.com	(508)579-9965
IBM Corporation Bromont	L04D9	Bromont, Quebec, Canada	Post Processing; Packaging/Assembly	Kyle Johnson	kylejohn@us.ibm.com	(919)830-5614
IBM Corporation Burlington	15898	Essex Junction, VT	Broker	Michael James / Christopher Koch	jamm@us.ibm.com / chmkoch@us.ibm.com	(802) 769-5069 / 802-769-1569
IBM Corporation East Fishkill	1D185	Hopewell Junction, NY	Broker	Michael James / Stepheh Crisalli	jamm@us.ibm.com / steve.crisalli@ibm.com	(802) 769-5069
Integra Technologies Silicon Valley	061F4	Milpitas, CA	Post Processing; Packaging/Assembly	Dave Fiore	david.fiore@integra-tech.com	(408) 618-8733
Integra Technologies, LLC	1SR1	Wichita, KS	Broker; Test	Dan Miller	Dan.Miller@integra-tech.com	(316) 630-6825
Intrinsix Corp.	0N6C1	Marlborough, MA	Broker; Design	Jim Gobes, CEO	jgobes@intrinsix.com	(508) 658-7658
Jazz Semiconductor Trusted Foundry (JSTF)	6PN00	Irvine, CA	Broker	Scott Jordan	Jordans1@jazztrusted.com	(949) 861-3519
Johns Hopkins University, Applied Physics Laboratory	88898	Laurel, MD	Design	Dan Silvera, ASIC Program Manager	Daniel.Silvera@jhuapl.edu	(240) 228-2059
Kansas City National Security Campus	14061	Kansas City, MO	Broker; Design; Aggregation; Post Processing; Packaging/Assembly; Test	Trusted Services Program Lead	mcaruso@kcp.doe.gov	(816) 488-5809
L-3 Communications Systems - West	06401	Salt Lake City, UT	Design	Rick Crist	rick.a.crist@L-3com.com	(801)594-3336
L3Harris Corporation Government Communications Systems Division	91417	Melbourne, FL	Design; Packaging/Assembly; Test	Louis Paradiso, Group Leader	lparadis@harris.com	(321) 727-5399
Lockheed Martin Missiles and Fire Control, Orlando	04939	Orlando, FL	Design	Zachary Davis	zachary.n.davis@lmco.com	(407)-356-1683
Lockheed Martin Space Systems Company, Denver	04236	Littleton, CO	Design	Deanna Doner, Sr. Manager ASIC/FPGA Design Services	deanna.e.doner@lmco.com	(303) 971-5392
Lockheed Martin Space Systems Company, Sunnyvale	06887	Sunnyvale, CA	Design	Deanna Doner, Sr. Manager ASIC/FPGA Design Services	deanna.e.doner@lmco.com	(303) 971-5392
Lockheed Martin Space Systems Company, Valley Forge	79272	King of Prussia, PA	Design	Deanna Doner, Sr. Manager ASIC/FPGA Design Services	deanna.e.doner@lmco.com	(303) 971-5392
M/A-COM Technology Solutions Inc.	55NN2	Lowell, MA	Foundry Services; Post Processing	Kim Conway	kimberly.conway@macomtech.com	(978) 656-2561
MacAulay-Brown, Inc.	6V5Z8	Roanoke, VA	Design	Barry Polakowski	Barry.Polakowski@macb.com	(540) 283-7555
Maxtek Components Corp. dba Tektronix Component Solutions	06MJ2	Beaverton, OR	Packaging/Assembly; Test	Christy Briggs	christy.briggs@tektronix.com	503-627-1351
Mercury System, Inc. - Phoenix Advanced Microelectronics Center	54230	Phoenix, AZ	Broker; Design; Packaging/Assembly; Test	Trusted Supplier	support@mrchy.com	(360) 921 8943
Mercury Systems - Sensor and Mission Processing	3X893	Andover, MA	Design	Trusted Supplier	support@mrchy.com	(657) 465-0208
Microsemi a subsidiary of Microchip Corp	0J4Z0	San Jose, CA	Broker; Design; Test	Paul Quintana	paul.quintana@microchip.com	
Microsemi a subsidiary of Microchip Corp, Allentown	6WGS8	Allentown, PA	Broker; Design; Aggregation; Test	Wayne Robert Kohler	wayne.kohler@microsemi.com	(408) 643-6040

MIT Lincoln Laboratory Microelectronics Laboratory	3G050	Lexington, MA	Design; Aggregation; Foundry Services; Post Processing; Packaging/Assembly	Director of the Microelectronics Laboratory, Adv Tech Div	MEL-Director@ll.mit.edu	(781) 981-7803
NEO Tech	09059	Chatsworth, CA	Packaging/Assembly	Steve Heinzen V.P. Marketing	steve.heinzen@neotech.com	(510) 933-6065
Northrop Grumman Aerospace Systems	11982	Redondo Beach, CA	Design; Aggregation; Foundry Services; Post Processing; Packaging/Assembly; Test	Myra de Leon	myra.deleon@ngc.com	(310) 813-2719
Northrop Grumman Mission Systems	15055	Linthicum, MD	Broker; Foundry Services; Packaging/Assembly; Test	Jeff Miller	j3.miller@ngc.com	(410) 765-3958
NSA Microelectronics Solutions Group	98230	Fort Meade, MD	Design; Packaging/Assembly; Test			
ON Semiconductor - Gresham	5V1J0	Gresham, OR	Broker; Foundry Services; Post Processing	Terry Danzer Marketing Manager - DMI	terry.danzer@onsemi.com	(208) 234-6009
ON Semiconductor - Pocatello	31471	Pocatello, ID	Broker; Design; Foundry Services; Test	Terry Danzer Marketing Manager - DMI	terry.danzer@onsemi.com	(208) 234-6009
Pantronix Corporation	2V289	Fremont, CA	Post Processing; Packaging/Assembly	Marketing Director	ptx@pantronix.com	(510) 656-5898
Photronics Texas Allen, Inc.	53Z12	Allen, TX	Mask Data Parsing; Mask Manufacturing	Wayne DeCarlo, VP North American	wdecarlo@photronics.com	(203) 740-5356
Plexus Aerospace Defense and Security Services LLC	76QV7	Nampa, ID	Packaging/Assembly	Daniel Marsh Director, Market Development	daniel.marsh@plexus.com	(480) 532-2467
Qorvo Texas, LLC	1CVM1	Richardson, TX	Foundry Services; Post Processing; Packaging/Assembly; Test	Douglas Cole	TrustedIC@qorvo.com	(972) 994-3965
Raytheon Missile Systems	15090	Tucson, AZ	Broker; Design	Bryon Hoinke	bryon_hoinke@raytheon.com	(520) 794-4226
Raytheon RF Components	05716	Andover, MA	Foundry Services	Ronald Gyurcsik, Ph.D. Director, Foundry Business Development	ronald.gyurcsik@raytheon.com	(978) 684-5428
Raytheon Space and Airborne Systems, El Segundo	4U884	El Segundo, CA	Design; Test	David E. Lewis	delewis@raytheon.com	(310) 607-7878
Raytheon Space and Airborne Systems, McKinney	96214	McKinney, TX	Design	David E. Lewis	delewis@raytheon.com	(310) 607-7878
Raytheon Vision Systems	11323	Goleta, CA	Design	Eric Beuville, PH.D.	Eric_Beuville@Raytheon.com	(805) 562-2021
Rockwell Collins, Inc.	13499	Cedar Rapids, IA	Design; Packaging/Assembly; Test	Gary Schardt	gary.schardt@rockwellcollins.com	(319) 295-1375
Sandia National Laboratories Microsystems Engineering, Science & Applications (MESA)	14213	Albuquerque, NM	Design; Foundry Services; Test	Nathan Nowlin, Manager, Advanced MicroElectronics & Radiation Effects	nnowlin@sandia.gov	(505) 845-0086
Sensors Unlimited, Inc.	0TGF6	Princeton, NJ	Aggregation; Post Processing; Packaging/Assembly; Test	Maria Veklich	Maria.VeklichHammond@utas.utc.com	(609)333-8248
Silanna Semiconductor	Z0FS6	Sydney Olympic Park, New South Wales, Australia	Design; Foundry Services; Post Processing	Jeremy Greenwood	jeremyg@silanna.com	61 2 9763 4135
Silicon Turnkey Solutions, Inc.	1VPP6	Milpitas, CA	Packaging/Assembly; Test	Laurence Jorstad	clewis@sts-usa.com	408-904-4225
Six Sigma (dba)	1PBC8	Milpitas, CA	Packaging/Assembly	Russ Winslow	russ@solderquik.com	(408) 956-0100 x111
SkyWater Technology Foundry, Inc.	5AZZ0	Bloomington, MN	Broker; Design; Foundry Services; Test	Brad Ferguson, CTO	brad.ferguson@skywatertechnology.com	(952) 851-5190

SRI International	0DKS7	Princeton, NJ	Foundry Services	David Weaver, PhD	David.weaver@sri.com	(609) 720-4845
Teledyne e2v HiRel Electronics	0C7V7	Milpitas, CA	Broker; Design; Packaging/Assembly; Test	Mont Taylor Dir. of Business Development	mont.taylor@e2v-us.com	(408) 609-8787
Teledyne Microelectronic Technologies	26687	Lewisburg, TN	Packaging/Assembly; Test	Harry Kellzi, Director Business Development	hkellzi@teledyne.com	(310) 990-9178
TLMI Corporation	3G0L2	Austin, TX	Post Processing	Michael Fredin	mfredin@tmicorp.com	(512) 833-7075
Trusted Semiconductor Solutions Inc.	4LZE5	Brooklyn Park, MN	Design; Aggregation	Stephanie Pusch	stephanie.pusch@trustedsemi.com	(612) 618-2115
TSI Semiconductors America, LLC	6SKN8	Roseville, CA	Foundry Services; Post Processing	Wilbur Catabay	wilbur.catabay@tsisemi.com	(408) 678.8691
USC - ISI Arlington	06SU2	Arlington, VA	Design	Matthew French	mfrench@isi.edu	(703) 812-3733
USC-ISI - MOSIS	1B729	Marina del Rey, CA	Broker; Aggregation	Wes Hansford, Deputy Director	hansford@mosis.com	(310) 448-9199
Vortex Aerospace Design & Labs, Inc.	35TC6	Melbourne, FL	Broker; Design; Aggregation; Mask Data Parsing	Curtis Turner	trustedDesign@vortexaerospace.com	(813) 435-0528

The Defense MicroElectronics Activity (DMEA) has been designated by the Department of Defense as the accrediting authority for this program. Send questions or comments to TrustedIC@dmea.osd.mil or call (916) 231-1514.



76 Trusted Suppliers

■ Design
 ■ Aggregation
 ■ Broker
 ■ Mask Data Parsing
 ■ Mask Manufacturing
 ■ Foundry
 ■ Post-Processing
 ■ Packaging/Assembly
 ■ Test

